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REACH

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RoHS

ID	R _{DS} (ON)(Typ)	VDSS
60A	5.4mΩ	40V

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

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Drdering Information								
Part Number	Package	Marking	Packing	Qty.				
RS40N60D	T0-252	RS40N60D	Tape&reel	2500 PCS				

Absolute Maximun Ratings Tc= 25°C unless otherwise specified

Symbol	Parameter	RS40N60D	Units
VDSS	Drain-to-Source Voltage	40	V
ID	Continuous Drain Current TC=25℃	60	
ID	Continuous Drain Current TC=100°C	38	А
IDM	Pulsed Drain Current (Note*1)	240	
PD	Power Dissipation	55	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 0.5mH, VDD = 20V, RG = 25 Ω,TC=25℃	100	mJ
	Maximum Temperature for Soldering	300	
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	260	°C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the" Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS40N60D	Units	Test Conditions
RØJC	Junction-to-Case	1.1	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^\circ C$
RθJA	Junction-to- Ambient	37		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	40			V	VGS=0V,ID=250µA
IDSS	Drain- to- Source Leakage Current			1	μA	VDS=40V,VGS=0V
	Gate- to- Source Forward Leakage			100		VGS=20V,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS=0 V

ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		5.4	6.8	mΩ	VGS=10V,ID=30A
			8.0	10.5	mΩ	VGS=4.5V,ID=20A
VGS(TH)	Gate Threshold Voltage	1.3	1.9	2.5	V	VGS=VDS,ID=250µ A

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter		Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		10			
trise	Rise Time		29			VDS=20V
td(OFF)	Turn- OFF Delay Time		39		nS	ID=20A RG=3Ω
tfall	Fall Time		8			



Dynamic Characteristics	Eccentially independent	ent of operating temperature
Dynamic Characteristics	Losennany mucpenue	in or operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		2440			VGS=0V
Coss	Output Capacitance		165		pF	VDS=20V
Crss	Reverse Transfer Capacitance		135			f=1.0MHz
Qg	Total Gate Charge		48			VDS=20V
Qgs	Qgs Gate- to- Source Charge		10		nC	ID=20A
Qgd	Gate-to-Drain(" Miller") Charge		10			VGS=10V

Source- Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
IS	Continuous Source Current			60	А	Integral pn- diode	
ISM	Maximum Pulsed Current	mum Pulsed Current 240 A		А	in MOSFET		
VSD	Diode Forward Voltage			1.2	V	IS=30A,VGS=0V	
trr	Reverse Recovery Time		11		nS	VGS=0V	
Qrr	Reverse Recovery Charge		5		nC	IS=20A di/dt=100A/μs	

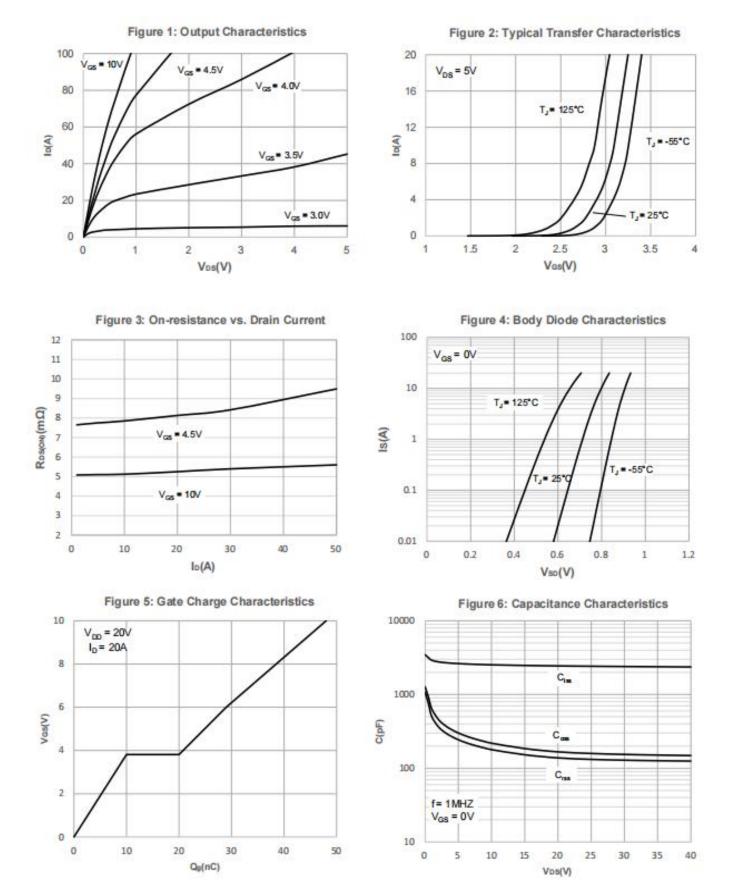
Notes:

* 1. Repetitive rating, pulse width limited by maximum junction temperature.

* 2. Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 0.5%



Typical Feature Curve



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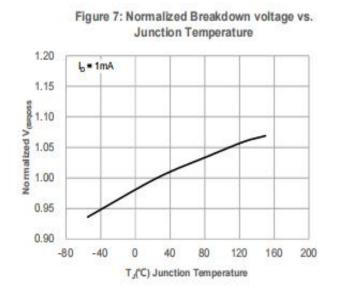
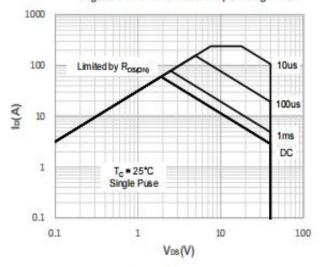
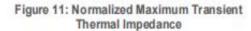
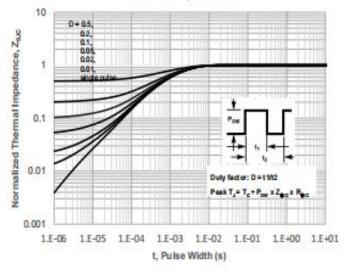


Figure 9: Maximum Safe Operating Area







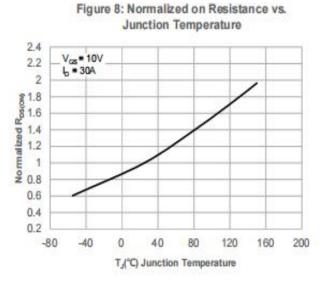


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

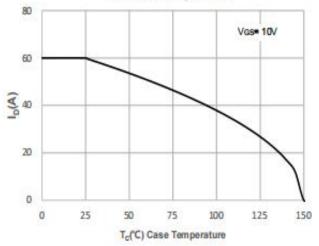
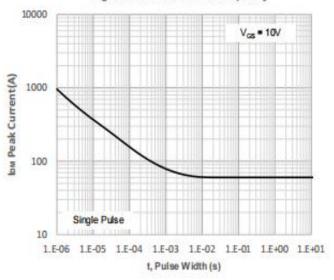


Figure 12: Peak Current Capacity



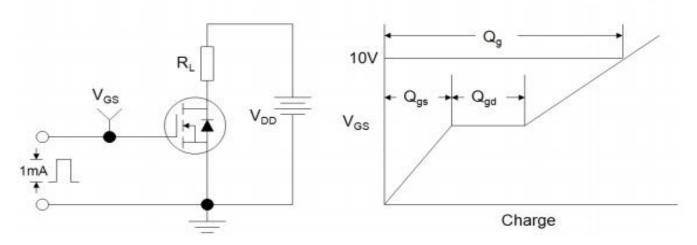
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Test ircuits and Waveforms







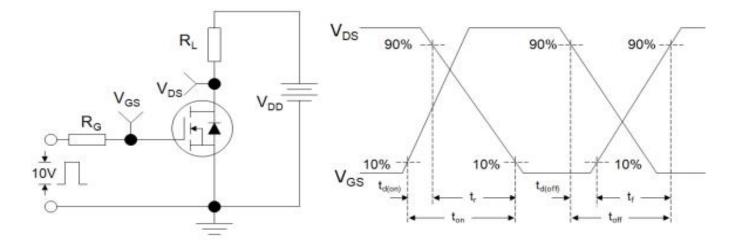
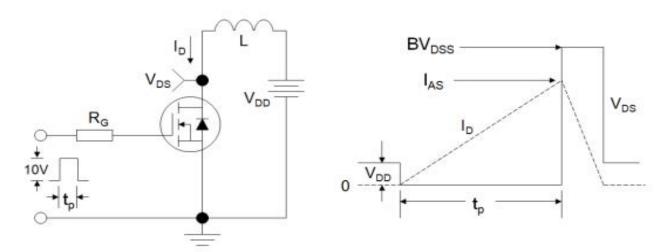


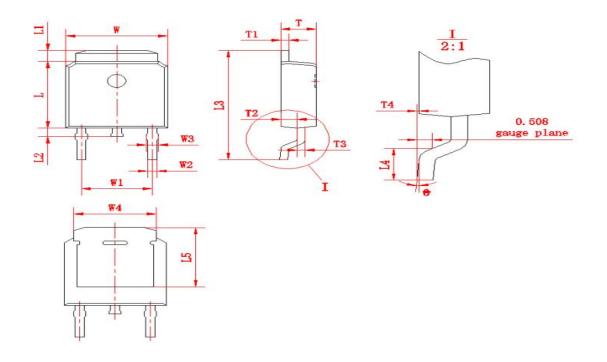
Figure Ct Unclamped Inductive Switching Test Circuit and Waveform



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Package outline drawing(TO-252 Unit: mm)



符号	尺	4	符号	尺寸 尺寸 符号 77		4		
12.2	Min	Max	17.2	Min	Max	17 2	Min	Max
W	6.50	6.70	L1	0.80	1.20	T1	0.48	0.58
W1	(4.5	572)	L2	0.60	1.00	T2	0.95	1.15
W2	0.6	0.8	L3	9.70	10.30	Т3	0.48	0.58
W3	0.68	0.88	L4	1.30	1.70	T4	0.00	0.12
W4	(5	.3)	L5	(5.20)		0	0	8
L	6.00	6.20	Т	2.20	2.40			



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